



50V N-Channel Enhancement Mode MOSFET - ESD Protected

Voltage

50 V

Current

400mA

Features

- R_{DS(ON)}, V_{GS}@10V, I_D@500mA<1.45Ω
- $R_{DS(ON)}$, $V_{GS}@4.5V$, $I_D@200mA<1.95\Omega$
- $R_{DS(ON)}$, $V_{GS}@2.5V$, $I_D@100mA<4.0\Omega$
- $R_{DS(ON)}$, $V_{GS}@1.8V$, $I_{D}@10mA<6.0\Omega$
- Advanced Trench Process Technology
- ESD Protected 2KV HBM
- Specially Designed for Relay driver, Speed line drive, etc.
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC61249 standard

Mechanical Data

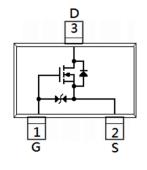
• Case: SOT-323 Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.0002 ounces, 0.005 grams







Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETE	SYMBOL	LIMIT	UNITS		
Drain-Source Voltage		V _{DS}	50	V	
Gate-Source Voltage	V _{GS}	<u>+</u> 20			
Continuous Drain Current(Note 4)		I _D	400	mA	
Pulsed Drain Current ^(Note 1)		I _{DM}	1200		
Power Dissipation	T _A =25°C	P _D	350	mW	
	Derate above 25°C		2.8	mW/°C	
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55~150	°C	
Typical Thermal Resistance - Junction to Ambient ^(Note 3,4)		R _{θJA}	357	°C/W	

Limited only By Maximum Junction Temperature





Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static			_			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	50	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} , I _D =250uA	0.5	0.86	1	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =500mA	-	1.2	1.45	Ω
		V _{GS} =4.5V, I _D =200mA	-	1.3	1.95	
		V _{GS} =2.5V, I _D =100mA	-	1.7	4.0	
		V _{GS} =1.8V, I _D =10mA	-	4.0	6.0	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =50V, V _{GS} =0V	-	-	1	uA
Gate-Source Leakage Current	Igss	V _{GS} = <u>+</u> 20V, V _{DS} =0V	-	-	<u>+</u> 10	
Dynamic ^(Note 5)						
Total Gate Charge	Q_g	V _{DS} =25V, I _D =500mA, V _{GS} =4.5V	-	0.95	-	nC
Gate-Source Charge	Qgs		-	0.34	-	
Gate-Drain Charge	Q_gd		-	0.32	-	
Input Capacitance	Ciss	V _{DS} =25V, V _{GS} =0V,	-	36	-	pF
Output Capacitance	Coss		-	11	-	
Reverse Transfer Capacitance	Crss	f=1MHZ	-	6.6	-	
Turn-On Delay Time	td _(on)		-	2.3	-	
Turn-On Rise Time	tr	V_{DD} =25V, I_{D} =500mA, V_{GS} =10V, R_{G} =6 Ω (Note 1,2)	-	20	-	ns
Turn-Off Delay Time	td _(off)		-	7	-	
Turn-Off Fall Time	tf	KG=012(1000 1,2)	-	20	-	
Drain-Source Diode			-			
Maximum Continuous Drain-Source Diode Forward Current	ls		-	-	500	mA
Diode Forward Voltage	V _{SD}	Is=500mA, V _{GS} =0V	-	0.9	1.5	V

NOTES:

- 1. Pulse width<300us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Rejah is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch² FR-4 with 2oz. square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing.





TYPICAL CHARACTERISTIC CURVES

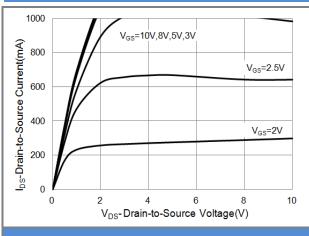


Fig.1 On-Region Characteristics

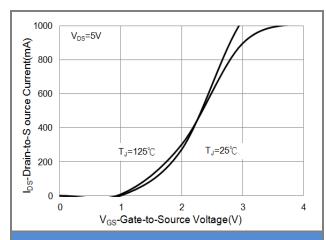


Fig.2 Transfer Characteristics

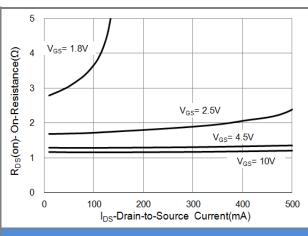


Fig.3 On-Resistance vs. Drain Current

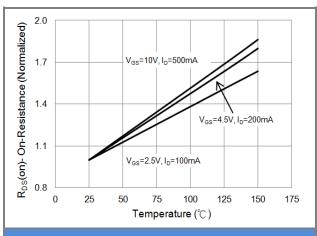
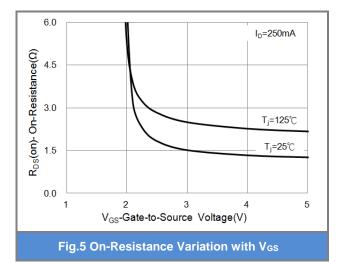
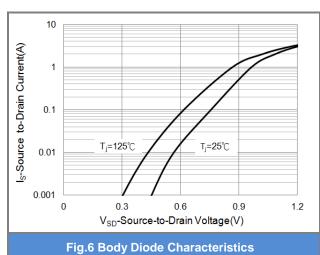


Fig.4 On-Resistance vs. Junction temperature









TYPICAL CHARACTERISTIC CURVES

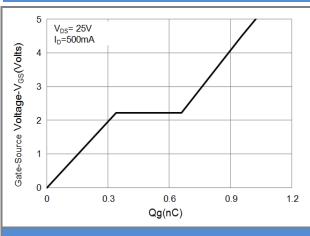


Fig.7 Gate-Charge Characteristics

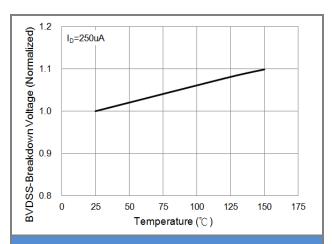


Fig.8 Breakdown Voltage Variation vs. Temperature

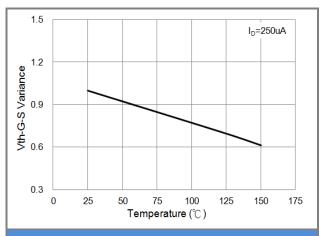


Fig.9 Threshold Voltage Variation with Temperature

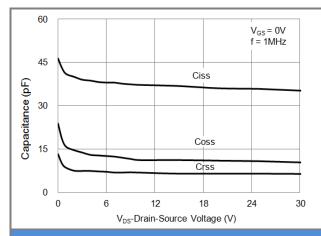


Fig.10 Capacitance vs. Drain-Source Voltage

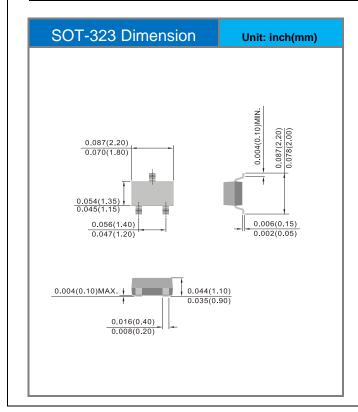


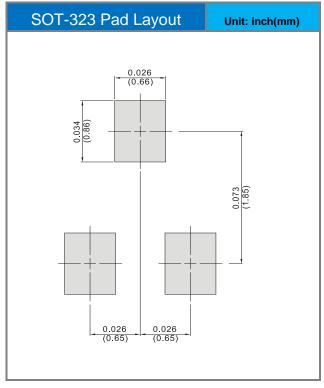


Part No. Packing Code Version

Part No. Packing Code	Package Type	Packing Type	Marking	Version
PJC7438-AU_R1_000A1	SOT-323	3K pcs / 7" reel	C38	Halogen free RoHS compliant

Packaging Information & Mounting Pad Layout









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